

Vector Control of Three-Phase Induction Motor Used in Driving a Fan

RX66T Implementation

Introduction

This application note describes how to use the sample program to drive a three phase induction motor (fan motor) with vector control using the RX66T microcontroller and the motor control development support tool 'Renesas Motor Workbench 2.0'.

The sample program is only provided for reference purposes and Renesas does not guarantee its operation. This sample program should only be used after thorough evaluation in an appropriate operating environment.

In particular, high-voltage environments are extremely dangerous. The information provided here should only be used after reading all the user's manuals for the development environment and observing all safety precautions. Renesas Electronics assumes no responsibility for an accident or loss occurring from the use of the development environments described in this document.

Target Device

Operation of the sample program provided with this application note has been verified for the following device.

- RX66T (R5F66TEADFP)

Target Sample Program

The sample program discussed in this application note is the following.

[1] RX66T100_T1102_3IM_LESS_FOC_CSP_FAN_V110

RX66T100 (R5F566TEADFP) T1102 sample program: Vector Control of Three-Phase Induction Motor Used in Driving a Fan

Reference Documents

- RX66T Group User's Manual: Hardware (R01UH0749EJ0110)
- Motor Control Application: Vector Control of Three-Phase Induction Motor (Algorithms)
- Motor Control Development Support Tool 'Renesas Motor Workbench 2.0'
Download from <https://www.renesas.com/us/en/software/D3017970.html>
- Trial series "T1102" 3kW 4kVA Inverter Unit User's Manual
- RX66T CPU Card User's Manual (R12UZ0029EJ0110)

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1. Overview

This application note describes how to implement a sample program for driving three-phase induction motor by vector control from the RX66T microcontroller, and how to use the library of 'Renesas Motor Workbench 2.0' (RMW)*¹, that is support tool for motor control development. Note that the sample program described here uses the algorithm described in the Motor Control Application: Vector Control of Three-Phase Induction Motor (Algorithms).

1.1 Development Environment

Table 1.1 lists the elements of the development environment for the sample program covered in this application note.

Table 1.1 Sample Program Development Environment

Sample Program	Microcontroller	Inverter Board	Motor	Version of CS+
[1]	R5F566TEADFP	T1102 * ²	MRS-25T * ³	V8.05.00

Contact your sales representative or authorized Renesas Electronics distributors for details on purchasing the T1102 inverter board and technical support.

Note 1. Motor Control Development Support Tool 'Renesas Motor Workbench 2.0' is products of Renesas Electronics Corporation.

Note 2. The T1102 inverter board and the In Circuit Scope development support tool are products of Desk Top Laboratories Inc.
Website: <http://desktoplab.co.jp/> (provided in Japanese only)

Note 3. MRS-25T is a product of Oriental Motor Co., Ltd.
Website: https://www.orientalmotor.co.jp/global_site/global_support/

2. System Overview

This section gives an overview of the system described in this application note.

2.1 Hardware Configuration

The hardware configuration is shown below.

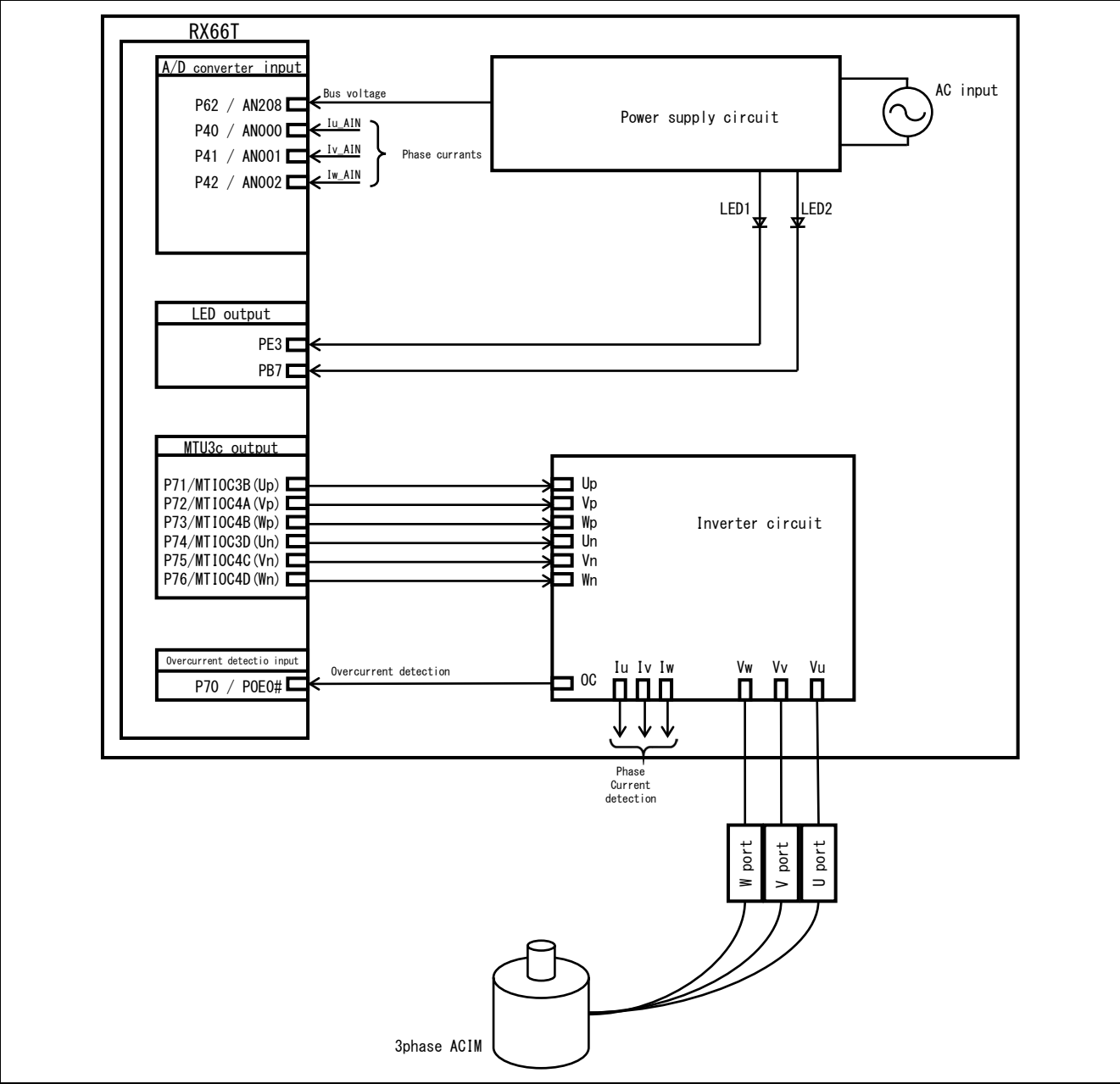


Figure 2.1 Hardware Configuration

2.2 Hardware Specifications

2.2.1 User Interface

Table 2.1 lists the user interfaces for use in this system.

Table 2.1 User Interfaces

Item	Interface Component	Function
LED1	Yellow-green LED	- Motor is running: On - Motor is stopped: Off
LED2	Yellow-green LED	- An error is detected: On - Normal operation: Off
RESET	Pushbutton switch RESET1	System reset

Table 2.2 lists the pin interfaces for use in this system.

Table 2.2 Pin Interfaces

R5F566TEADFP Pin Name	Function
P62/AN208	Inverter bus voltage measurement
PE3	LED1 on/off control
PB7	LED2 on/off control
P40/AN000	Measurement of the U-phase current
P41/AN001	Measurement of the V-phase current
P42/AN002	Measurement of the W-phase current
P63/AN209 ^{*1}	Measurement of the intelligent power module (IPM) temperature
P71/MTIOC3B	Complementary PWM output (U_p)
P72/MTIOC4A	Complementary PWM output (V_p)
P73/MTIOC4B	Complementary PWM output (W_p)
P74/MTIOC3D	Complementary PWM output (U_n)
P75/MTIOC4C	Complementary PWM output (V_n)
P76/MTIOC4D	Complementary PWM output (W_n)
P70/POE0#	Input for the emergency signal for stopping the PWM output on detection of an overcurrent

Note 1. Not connected on the CPU board (function is disabled)

2.2.2 Peripheral Modules

The peripheral modules for use with this system are listed below.

Table 2.3 Peripheral Modules for Use with the Sample Program

MCU	12-bit ADC	CMT	MTU3d	POE3b
RX66T	- Individual currents of U/V/W phases - Inverter bus voltage	1-ms interval timer	Complementary PWM output	Initialization of the complementary PWM output port (The pins being used for PWM output are placed in the high-impedance state and PWM output is stopped)

(1) 12-bit A/D converter

Using 12-bit A/D converters to measure the U-, V-, and W-phase currents (I_u , I_v , and I_w), inverter bus voltage (V_{dc}).

The operating mode differs for each converter unit. Unit 0 is set to group scan mode, with use of the sample-and-hold function (use synchronous trigger to start conversion) and unit 2 is set to continuous scan mode.

(2) Compare match timer (CMT)

Channel 0 of the compare match timer is used as a 1-ms interval timer.

(3) Multi-function timer pulse unit 3 (MTU3d)

The operating mode varies with channels, with channels 3 and 4 being used in complementary PWM mode to output an active-high signal that includes dead time.

(4) Port output enable 3 (POE3)

When an overcurrent is detected (indicated by a falling edge on the POE0# pin) or when an output short-circuit is detected, the pins being used for PWM output are placed in the high-impedance state, PWM output is stopped, and the complementary PWM output port pins are initialized.

2.3 Software Configuration

2.3.1 File Configuration

Table 2.4 lists the folders and files for this sample program.

Table 2.4 Folders and Files for the Sample Program [1]

Sample Program	Folder Name	File Name	Description
RX66T100_T1102_ 3IM_LESS_FOC_ CSP_FAN_V100	Inc	main.h	Main function and user interface control header file
		mtr_common.h	Common definitions header file
		mtr_ctrl_t1102.h	Board-dependent processing header file
		mtr_ctrl_rx66t100.h	RX66T-dependent processing header file
		mtr_3im_less_foc.h	Sensorless vector control header file
		control_parameter.h	Control parameter header file
		motor_parameter.h	Motor parameter header file
		mtr_ctrl_rx66t100_t1102.h	Board- and RX66T-dependent processing header file
		r_init_clock.h	Header file for initial setting of the clock signals for the RX66T
		r_init_port_initialize.h	Header file for initialization of the RX66T port pins
		r_init_rom_cache.h	Header file for initialization of the ROM cache of the RX66T
		r_init_stop_module.h	Header file for stop processing of peripheral modules of the RX66T
	Ics	ICS2_RX66T.lib	ICS library
		ICS2_RX66T.h	ICS library header file
	Src	main.c	Main function and user interface control header file
		mtr_ctrl_t1102.c	Board-dependent processing
		mtr_ctrl_rx66t100.c	RX66T-dependent processing
		mtr_interrupt.c	Interrupt handlers
		mtr_3im_less_foc.c	Sensorless vector control
		mtr_ctrl_rx66t100_t1102.c	Board- and RX66T-dependent processing
		r_init_clock.c	Initial setting of the clock signals for the RX66T
		r_init_port_initialize.c	Initialization processing of the RX66T port pins
		r_init_rom_cache.c	Initialization processing of the ROM cache of the RX66T
		r_init_stop_module.c	Stop processing of the peripheral modules of the RX66T

2.3.2 Configuration of the Sample Program

The software modules used in this sample program are shown in Figure 2.2 and Table 2.5.

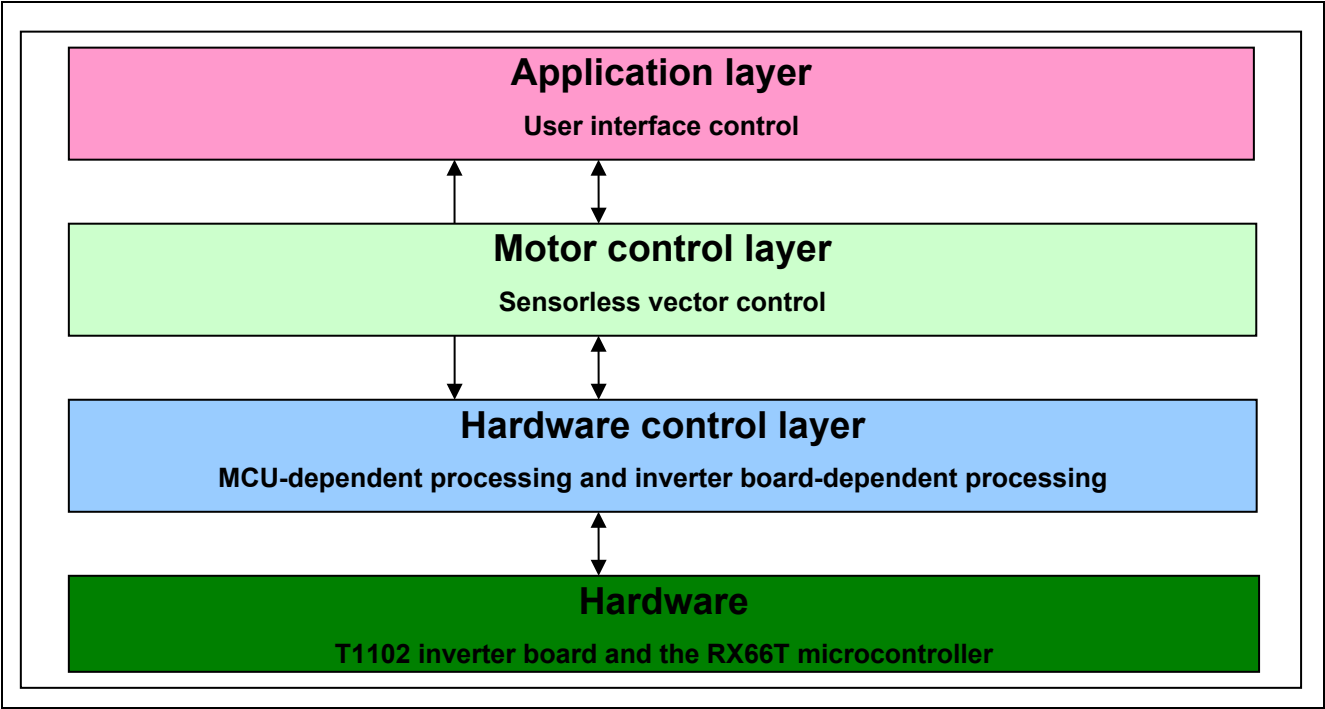


Figure 2.2 Configuration of the Software Modules Used in the Sample Program

Table 2.5 Configuration of the Software Modules Used in the sample Program [1]

Layer	File
Application layer	main.c
Motor control layer	mtr_3im_less_foc.c
Hardware control layer	mtr_ctrl_rx66t100_t1102.c
	mtr_ctrl_rx66t100.c
	mtr_ctrl_t1102.c
	r_init_clock.c
	r_init_port_initialize.c
	r_init_rom_cache.c
	r_init_stop_module.c

2.4 Software Specifications

Table 2.6 lists the basic specifications of this system software. See the Motor Control Application: Vector Control of Three-Phase Induction Motor (Algorithms) for details on the vector control.

Table 2.6 Basic Specifications of the Vector Control Program (for Sample Program [1])

Item	Description
Control method	Vector control
Starting and stopping of motor rotation	Handled by RMW (See the 'com_s2_mode_system' variable in Table 4.1.)
Detection of rotor's magnetic pole position	Sensorless
Input voltage	AC 220 V
Carrier frequency (PWM)	16 kHz
Control period	125 μ s (twice the carrier period)
Rotational speed range	500 rpm to 2000 rpm * ¹
System protection	- The motor control signal outputs (6 lines) are set to the inactive level in response to any of the following four conditions. - The current in any phase exceeds 3 A (monitored once every 125 μs). - The inverter bus voltage exceeds 420 V (monitored once every 125 μs). - The inverter bus voltage falls below 0 V (monitored once every 125 μs). - The speed exceeds 2600 rpm (monitored once every 125 μs). - The pins being used for PWM output are placed in the high-impedance state in response to external input of an overcurrent detection signal (detection of a falling edge on the POE0# pin).

Note 1. There may be a difference between the actual speed and the reference speed depending on the working environment.

3. Control Program

This section describes the sample program covered in this application note.

3.1 Control

3.1.1 Starting and Stopping the Motor

Starting and stopping of the motor are controlled by using RMW to set a value to the motor operation variable "com_s2_mode_system".

The variable for motor operation is read in the main loop, and if the value is found to have been changed, it is determined that the user has set by using PMW, and the state changes according to the value. As shown in Table 4.1, write '1' to the motor operation variable will change the motor to the running state, and write '0' to the motor operation variable will change the motor to the stopped state. Also write '3' to the motor operation variable will reset the error state.

3.1.2 Motor Rotation Speed Command

Using RMW to set rotation speed command value in 'com_s2_ref_speed_rpm'. The unit of the speed command value is rpm.

3.1.3 Inverter Bus Voltage

As shown in the table below, the measured values of the inverter bus voltage are used in producing the modulation factor and for overvoltage detection. Detection of abnormal voltages leads to stopping of the PWM output.

Table 3.1 Conversion Ratio for Inverter Bus Voltage

Item	Sample Program	Conversion Ratio (Inverter bus voltage: A/D converted value)	Channel
Inverter bus voltage	[1]	0 V to 686.5 V: 0000H to 0FFFH	AN208

3.1.4 Phase Current

As shown in the table below, the measured values of U-, V-, and W-phase currents are used for vector control and overcurrent detection.

Table 3.2 Conversion Ratio for U-, V-, W-Phase Currents

Item	Sample Program	Conversion Ratio (U-, V-, W-phase currents: A/D converted value)	Channel
U-, V-, W-phase currents	[1]	-50 A to 50 A: 0000H to 0FFFH	Iu: AN000 Iv: AN001 Iw: AN002

3.1.5 Modulation

In this sample program, the voltage to be input to the motor is generated by pulse width modulation (PWM). Comparison of the PWM waveform with a triangular waveform determines the pulse width for use in providing the input voltage.

(1) Triangle Wave Comparison Method

This is the method for the physical output of the desired voltage. The pulse width for the voltage to be output is determined on the basis of the results of comparing the command voltage waveform with the carrier waveform (triangle wave). The desired voltage is output as a pseudo-sinusoidal waveform by switching the output on when the voltage is greater than that produced by the carrier wave and off when the voltage is lower than that produced by the carrier wave.

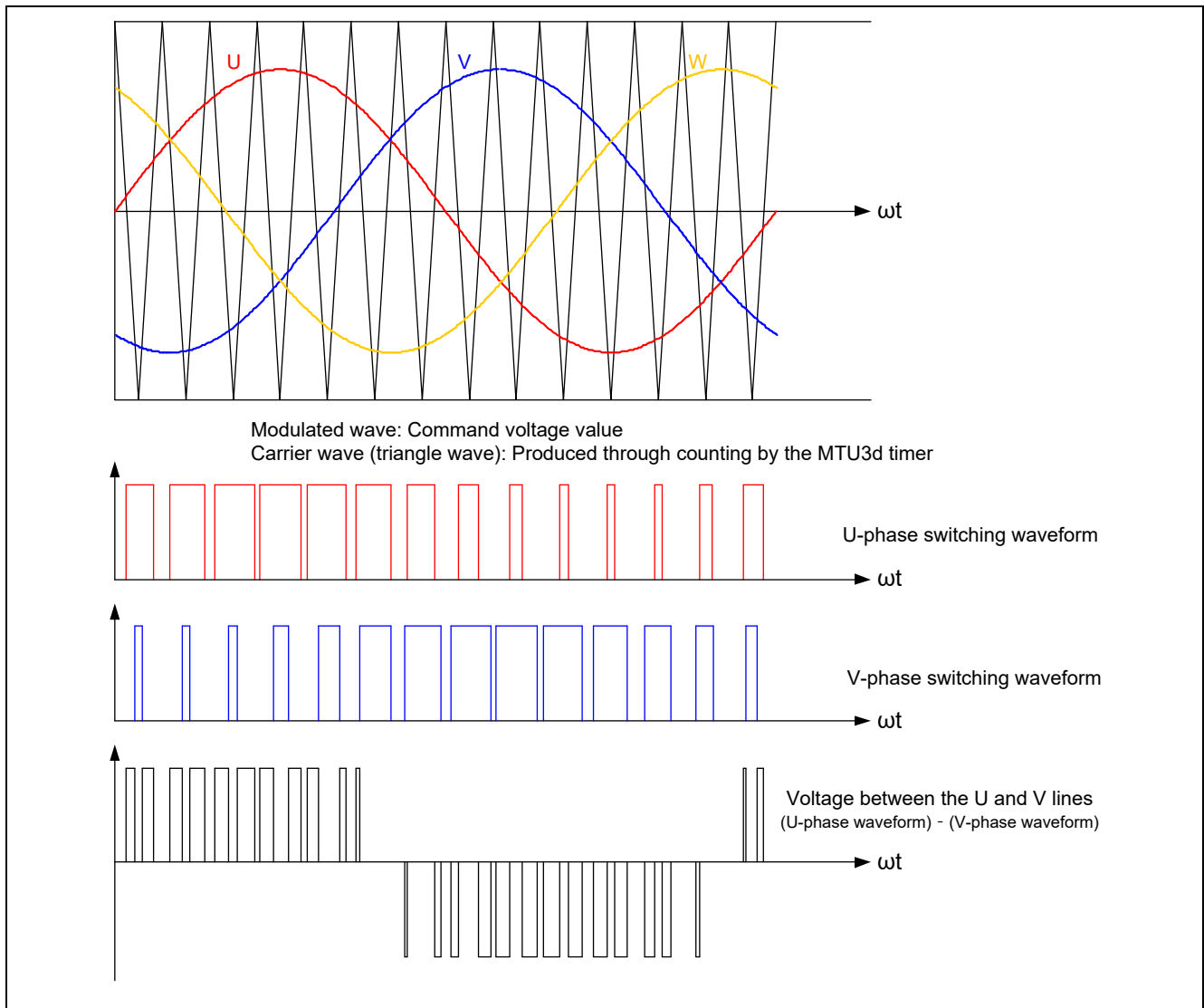


Figure 3.1 Concepts of Triangle Wave Comparison Method

Here, as shown in Figure 3.2, the ratio of the output voltage pulse to the carrier wave is called duty.

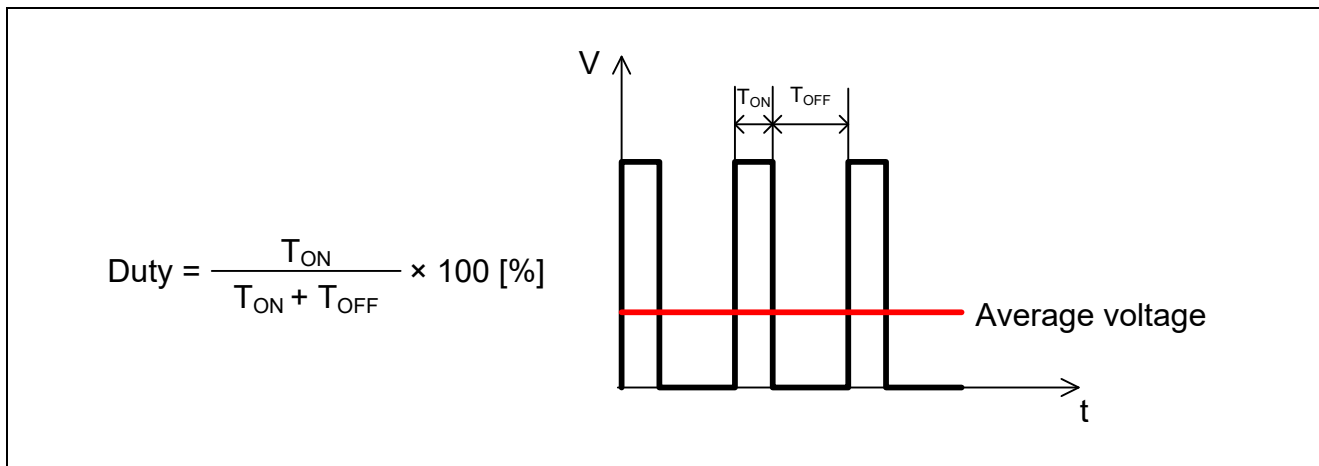


Figure 3.2 Definition of Duty

The modulation factor m is defined as follows.

$$m = \frac{V}{E}$$

m : Modulation factor V : Command value voltage E : Inverter bus voltage

A desired control is accomplished by setting this modulation factor to the register for use in determining the PWM duty.

3.1.6 State Transitions

Figure 3.3 shows the state transitions within the sensorless vector control program.

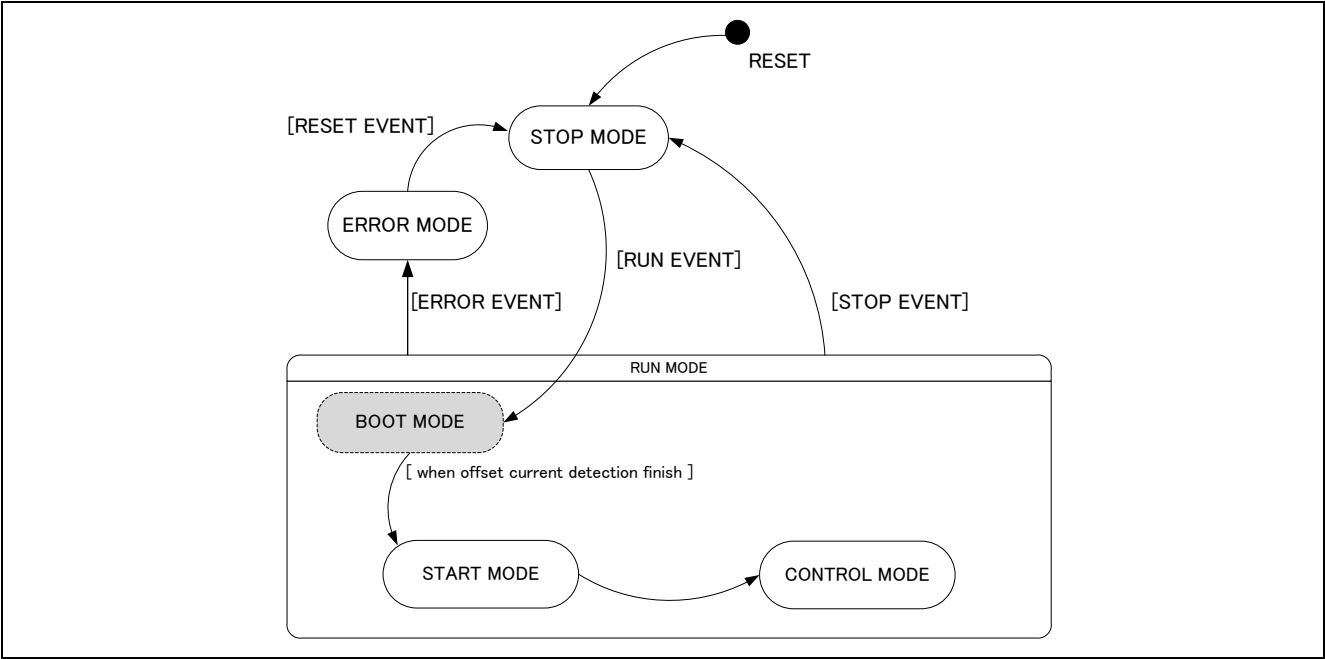


Figure 3.3 State Transitions within the Sensorless Vector Control Program

3.1.7 System Protection Functions

This control program detects the following five errors and initiates an emergency stop in response to each of them. See Table 3.3 for the values used for the system protection functions.

- **Overcurrent error**
The PWM output pins are placed in the high-impedance state in response to an emergency stop signal (over current detection) from the hardware.
In addition, U-, V-, and W-phase currents are monitored in overcurrent monitoring cycles. When an overcurrent (the current exceeding the overcurrent limit value) is detected, the CPU initiates an emergency stop of the PWM output (in response to detection by the software).
- **Overvoltage error**
The inverter bus voltage is monitored in overvoltage monitoring cycles. When an overvoltage (the voltage exceeding the overvoltage limit value) is detected, the CPU initiates an emergency stop of the PWM output.
- **Undervoltage error**
The inverter bus voltage is monitored in low-voltage monitoring cycles. The CPU initiates an emergency stop of the PWM output when low voltage (the voltage falls below the limit value) is detected.
- **Rotational speed error**
Rotational speed is monitored in speed monitoring cycles and if the speed limit is exceeded, the CPU initiates an emergency stop of the PWM output.

Table 3.3 Values for the System Protection Functions in Sample Program [1]

Error	Item	Value
Overcurrent error	Overcurrent limit value [A]	3
	Monitoring cycle [μ s]	125
Overvoltage error	Overvoltage limit value [V]	420
	Monitoring cycle [μ s]	125
Undervoltage error	Undervoltage limit value [V]	0
	Monitoring cycle [μ s]	125
Rotational speed error	Speed limit value [rad/s] (electrical angle)	272
	Monitoring cycle [μ s]	125

3.2 Functions for Use in Vector Control Software Program

The control program uses multiple control functions as listed in the table below. See the flowcharts and the source code for more detailed information on the processing performed by these functions.

Table 3.4 Control Functions (1/7)

File Name	Function Name	Processing Overview
main.c	main	• Calls the hardware initialization function • Calls the user interface initialization function • Calls the main processing variables initialization function • Calls the function to execute state transitions and events • Main processing ⇒ Calls the function that performs the main processing ⇒ Calls the watchdog timer clear function
	ics_ui	For use by the ICS user interface
	software_init	Initializes variables used in the main processing
mtr_ctrl_t1102.c	R_MTR_ChargeCapacitor	Waits for the charging time for the smoothing capacitor
	ic_gate_on	Sets the gate signal used for inrush prevention to the ON state
	led1_on	Turns on LED1
	led2_on	Turns on LED2
	led1_off	Turns off LED1
	led2_off	Turns off LED2
	get_sw1	Gets the state of SW1
	get_sw2	Gets the state of SW2
	get_sw3	Gets the state of SW3
	get_vr1	Gets the A/D converted value of the rotational speed command

Table 3.4 Control Functions (2/7)

File Name	Function Name	Processing Overview
mtr_ctrl_rx66t100.c	R_MTR_InitHardware Input: None Output: None	Initializes clock signals and peripheral modules
	mtr_init_cmt Input: None Output: None	Initializes the CMT
	mtr_init_poe3 Input: None Output: None	Initializes the POE3
	init_wdt Input: None Output: None	Initializes the WDT
	clear_wdt Input: None Output: None	Clears the WDT
	mtr_clear_oc_flag Input: None Output: None	Releases the high-impedance state
	mtr_clear_cmt0_flag Input: None Output: None	Clears the interrupt flag

Table 3.4 Control Functions (3/7)

File Name	Function Name	Processing Overview
mtr_interrupt.c	mtr_groupBL1_interrupt Input: None Output: None	Group interrupt which includes an overcurrent detection as a source • Calls the overcurrent detection processing
	mtr_over_current_interrupt Input: None Output: None	Overcurrent detection processing • Calls the event processing selection function • Changes the motor status • Calls the function that clears the high-impedance state
	mtr_mtu4_interrupt Input: None Output: None	Called once every 125 μ s • Vector control • Current PI control
	mtr_cmt0_interrupt Input: None Output: None	Called once every 1 ms • Startup control • Speed PI control

Table 3.4 Control Functions (4/7)

File Name	Function Name	Processing Overview
mtr_3im_less_foc.c	R_MTR_InitSequence Input: None Output: None	Sequence processing initialization
	R_MTR_ExecEvent Input: (uint8)u1_event/ event that occur Output: None	• Updates the motor state • Calls the function that handles the appropriate processing in response to events that occur
	mtr_act_run Input: (uint8)u1_state/ motor status Output: (uint8)u1_state/ motor status	• Calls the function that initializes the variables used at motor startup • Calls the function that starts motor control
	mtr_act_stop Input: (uint8)u1_state/ motor status Output: (uint8)u1_state/ motor status	Calls the function that terminates motor control
	mtr_act_none Input: (uint8)u1_state/ motor status Output: (uint8)u1_state/ motor status	No processing
	mtr_act_reset Input: (uint8)u1_state/ motor status Output: (uint8)u1_state/ motor status	Initializes global variables
	mtr_act_error Input: (uint8)u1_state/ motor status Output: (uint8)u1_state/ motor status	Calls the function that terminates motor control
	mtr_start_init Input: None Output: None	Initializes only those variables needed at motor startup
	mtr_stop_init Input: None Output: None	Initializes variables needed at motor stop
	mtr_pi_ctrl Input: MTR_PI_CTRL *pi_ctrl/ structure for PI control Output: (float32)f4_ref/ PI control output value	Used in PI control
	mtr_set_variables Input: None Output: None	Sets the motor variables
	R_MTR_IcsInput Input: MTR_ICS_INPUT *ics_input/ structure for ICS Output: None	Sets up buffers

Table 3.4 Control Functions (5/7)

File Name	Function Name	Processing Overview
	R_MTR_SetDir Input: (uint8)dir/ rotational direction Output: None	Sets the direction of rotation
	R_MTR_GetSpeed Input: None Output: (float32)f4_speed_rpm/ speed	Acquires the speed calculation value
	R_MTR_GetDir Input: None Output: (uint8)g_u1_direction	Acquires the value of the rotational direction
	R_MTR_GetStatus Input: None Output: (uint8)g_u1_mode_system/ motor status	Acquires the motor status
	mtr_error_check Input: None Output: None	Error monitoring and detection
	mtr_set_speed_ref Input: None Output: None	Sets the command used for speed control
	mtr_set_iq_ref Input: None Output: None	Sets the δ axis current command
	mtr_set_id_ref Input: None Output: None	Sets the γ axis current command
	mtr_calc_mod Input: (float32) f4_vu/ U-phase voltage (float32) f4_vv/ V-phase voltage (float32) f4_vw/ W-phase voltage (float32) f4_vdc/ bus voltage Output: None	Modulation factor calculation

Table 3.4 Control Functions (6/7)

File Name	Function Name	Processing Overview
mtr_ctrl_rx66t_t1102.c	mtr_init_mtu Input: None Output: None	Initialization of the MTU3d
	mtr_init_io_port Input: None Output: None	Initialization of the I/O ports
	mtr_init_ad_converter Input: None Output: None	Initialization of the A/D converters
	init_ui Input: None Output: None	Initialization of the user interfaces
	mtr_ctrl_start Input: None Output: None	Motor startup processing
	mtr_ctrl_stop Input: None Output: None	Motor stop processing
	mtr_get_iuivwvdc Input: (float32)*f4_iu_ad/ A/D converted value of U-phase current (float32)*f4_iv_ad/ A/D converted value of V-phase current (float32)*f4_iw_ad/ A/D converted value of W-phase current (float32)*f4_vdc_ad/ A/D converted value of Vdc Output: None	A/D conversion of U-, V-, and W-phase currents and inverter bus voltage
	mtr_get_ipm_temperature Input: None Output: (int16)s2_temp/A/D converted value of the IPM temperature voltage	A/D conversion of the IPM temperature
	mtr_clear_mtu4_flag Input: None Output: None	Clears the interrupt flag
	mtr_inv_set_uvw Input: (float32)f4_modu/ U phase modulation factor (float32)f4_modv/ V phase modulation factor (float32)f4_modw/ W phase modulation factor Output: None	PWM output setting
	mtr_init_register Input: None Output: None	Initialization for the PWM value comparison

Table 3.4 Control Functions (7/7)

File Name	Function Name	Processing Overview
r_init_clock.c	R_INIT_Clock	Initialization of the clock signals
	Input: None	
	Output: None	
	CGC_oscillation_main	Main clock oscillation setting
	Input: None	
	Output: None	
	CGC_oscillation_PLL	PLL clock oscillation setting
	Input: None	
	Output: None	
	CGC_oscillation_HOCO	HOCO clock oscillation setting
	Input: None	
	Output: None	
r_init_port_initialize.c	R_INIT_Port_Initialize	Initialization of ports that are not present
	Input: None	
	Output: None	
r_init_rom_cache.c	R_INIT_ROM_Cache	Initialization of the ROM cache
	Input: None	
	Output: None	
r_init_stop_module.c	R_INIT_StopModule	Stops peripheral modules which are running after a reset
	Input: None	
	Output: None	

3.3 Software Variables Used in the Sensorless Vector Control Program

The table below lists the variables used in the control program.

Table 3.5 List of Variables (1/3)

Variable Name	Type	Content	Remark
g_u1_mode_system	uint8	State management	0: Stop mode 1: Run mode 2: Error mode
g_u2_run_mode	uint16	Operating mode management	0: Boot mode 2: Control mode
g_u2_ctrl_mode	uint16	Control mode management	1: Open loop mode 5: Sensorless vector control mode
g_u1_error_status	uint8	Error status management	1: Overcurrent error 2: Overvoltage error 3: Rotational speed error 7: Low voltage error 8: IPM temperature error 0xFF: Undefined error
g_f4_vdc_ad	float32	Inverter bus voltage	[V]
g_f4_vd_ref	float32	γ axis output voltage command	[V]
g_f4_vq_ref	float32	δ axis output voltage command	[V]
g_f4_iu_ad	float32	U-phase current	[A]
g_f4_pre_iu_ad	float32	Previous U-phase current value	[A]
g_f4_iv_ad	float32	V-phase current	[A]
g_f4_pre_iv_ad	float32	Previous V-phase current value	[A]
g_f4_iw_ad	float32	W-phase current	[A]
g_f4_pre_iw_ad	float32	Previous W-phase current value	[A]
g_f4_offset_iu	float32	U-phase current offset	[A]
g_f4_offset_iv	float32	V-phase current offset	[A]
g_f4_offset_iw	float32	W-phase current offset	[A]
g_f4_id_lpf	float32	γ axis current	[A]
g_f4_iq_lpf	float32	δ axis current	[A]
g_f4_pre_id_lpf	float32	Previous γ axis current value	[A]
g_f4_pre_iq_lpf	float32	Previous δ axis current value	[A]
g_f4_kp_id	float32	γ axis current PI control proportional gain	
g_f4_ki_id	float32	γ axis current PI control integral gain	
g_f4_lim_id	float32	γ axis current PI control limit value	[A]
g_f4_ilim_id	float32	γ axis current PI control integral limit value	[A]
g_f4_kp_iq	float32	δ axis current axis current PI control proportional gain	
g_f4_ki_iq	float32	δ PI control integral gain	
g_f4_lim_rotor_speed_rad	float32	Rotor speed PI control limit value	Electrical angle [rad/s]
g_f4_ilim_rotor_speed_rad	float32	Rotor speed PI control integral limit value	Electrical angle [rad/s]
g_f4_id_ref	float32	γ axis current command	[A]
g_f4_iq_ref	float32	δ axis current command	[A]
g_f4_ref_stator_speed_rad	float32	Stator speed command	Electrical angle [rad/s]

Table 3.5 List of Variables (2/3)

Variable Name	Type	Content	Remark
g_f4_slip_speed_rad	float32	Slip speed	Electrical angle [rad/s]
g_f4_slip_k	float32	Slip speed gain	
g_f4_speed_rad	float32	Calculated speed value	Electrical angle [rad/s]
g_f4_ref_speed_rad_pi	float32	Calculated value for speed PI control	Electrical angle [rad/s]
g_f4_ref_speed_rad	float32	Speed command	Electrical angle [rad/s]
g_f4_angle_rad	float32	Rotor interlinkage flux phase	[rad]
g_f4_max_speed_rad	float32	Maximum speed command value	[rad/s]
g_f4_min_speed_rad	float32	Minimum speed command value	[rad/s]
g_f4_refu	float32	U-phase voltage command	[V]
g_f4_refv	float32	V-phase voltage command	[V]
g_f4_refw	float32	W-phase voltage command	[V]
g_f4_inv_limit	float32	Phase voltage limit value	[V]
g_f4_speed_lpf_k	float32	Speed LPF gain	
g_f4_current_lpf_k	float32	Current LPF gain	
g_f4_offset_lpf_k	float32	Current offset LPF gain	
g_u1_direction	uint8	Rotational direction command	0: CW 1: CCW
g_u1_enable_write	uint8	Variable for use by the user interface of the ICS	
g_u2_cnt_adjust	uint16	Counter for use in current offset calculation	
g_u1_flag_id_ref	uint8	γ axis current command management flag	0: γ axis current increases 1: γ axis current is constant 2: γ axis current is constant (speed control)
g_f4_temp_speed_rad	float32	Variable for holding speed value	Electrical angle [rad/s]
g_f4_temp_ref_speed_rad	float32	Variable for holding speed command value	Electrical angle [rad/s]
g_f4_angle_compensation	float32	Phase compensation constant	
g_f4_offset_calc_time	float32	Current offset calculation time	[ms]
g_f4_voltage_drop	float32	Voltage drop correction threshold	[V]
g_f4_voltage_drop_k	float32	Voltage drop correction gain	
g_f4_modu	float32	U phase modulation factor	
g_f4_modv	float32	V phase modulation factor	
g_f4_modw	float32	W phase modulation factor	
rotor_speed	MTR_PI_CTRL	Rotor speed PI control structure	
id_ACR	MTR_PI_CTRL	γ axis current PI control structure	

Table 3.5 List of Variables (3/3)

Variable Name	Type	Content	Remark
g_f4_kp_speed	float32	Speed PI control proportional gain	
g_f4_ki_speed	float32	Speed PI control integral gain	
g_f4_lim_iq	float32	δ axis current PI control limit value	[A]
g_f4_ilim_iq	float32	δ axis current PI control integral limit value	[A]
g_u1_dir_buff	uint8	Variable for storing the commanded rotational direction	0: CW 1: CCW
g_f4_id_ref_buff	float32	Variable for storing γ axis current command	[A]
g_f4_iq_ref_buff	float32	Variable for storing δ axis current command	[A]
g_u1_flag_iq_ref	uint8	δ axis current command management flag	0: δ axis current 0 1: Speed PI output
g_u1_flag_speed_ref	uint8	Speed command management flag	0: Speed = 0 1: Speed changes
mtr_p	MTR_PARAMETER	Motor parameters and control parameters	
g_u1_flag_offset_calc	uint8	Current offset calculation flag	0: Calculated at transition to boot mode 1: Calculated at transition to boot mode (first time only)
g_f4_boot_id_up_step	float32	γ axis current additional value at startup	[A]
g_f4_fluctuation_limit	float32	Speed fluctuation limit	[rad/s]
g_f4_ctrl_ref_id	float32	γ axis current command	[A]
g_u2_cnt_id_const	uint16	γ axis current flux stabilization wait time counter	
g_f4_id_const_time	float32	γ axis current flux stabilization wait time	[ms]
g_f4_accel	float32	Acceleration	[rad/s ²]
g_f4_ipm_temperature_ad	float32	The IPM temperature that is converted to voltage	[V]
speed	MTR_PI_CTRL	Structure for use in speed PI control	
ics_input_buff	MTR_ICS_INPUT	Structure for the ICS user interface	

3.4 Structures Used in the Sensorless Vector Control Software

The table below lists the structures used in the control program.

Table 3.6 List of Structures

	Member Name	Type	Description	Remarks
MTR_PI_CTRL	f4_err	float32	Differential	
	f4_kp	float32	PI control proportional gain	
	f4_ki	float32	PI control integral gain	
	f4_limit	float32	PI control output limit value	
	f4_refi	float32	PI control integral output value	
	f4_ilimit	float32	PI control integral limit value	
MTR_PARAMETER	f4_mtr_rs	float32	Stator resistance	[Ω]
	f4_mtr_rr	float32	Rotor resistance	[Ω]
	f4_mtr_m	float32	Magnetizing inductance	[H]
	f4_mtr_ls	float32	Stator leakage inductance	[H]
	f4_mtr_lr	float32	Rotor leakage inductance	[H]
	f4_mtr_m_lr	float32	f4_mtr_m/f4_mtr_lr	
	f4_mtr_rr_lr	float32	f4_mtr_rr/f4_mtr_lr	
	f4_mtr_sigma	float32	1.0 - f4_mtr_m/f4_mtr_ls * f4_mtr_m_lr	
	f4_mtr_ls_sigma	float32	f4_mtr_ls * f4_mtr_sigma	
MTR_ICS_INPUT	s2_ref_speed	int16	Speed command	Mechanical angle [rpm]
	s2_direction	int16	Rotational direction	0: CW 1: CCW
	f4_kp_speed	float32	Speed PI control proportional gain	
	f4_ki_speed	float32	Speed PI control integral gain	
	f4_kp_iq	float32	δ axis current PI control proportional gain	
	f4_ki_iq	float32	δ axis current PI control integral gain	
	f4_speed_lpf_k	float32	Speed LPF gain	
	f4_current_lpf_k	float32	Current LPF gain	
	f4_mtr_rs	float32	Stator resistance	[Ω]
	f4_mtr_rr	float32	Rotor resistance	[Ω]
	f4_mtr_m	float32	Magnetizing inductance	[H]
	f4_mtr_lis	float32	Stator leakage inductance	[H]
	f4_mtr_lir	float32	Rotor leakage inductance	[H]
	f4_offset_lpf_k	float32	Current offset value LPF gain	
	s2_max_speed	int16	Maximum speed	Mechanical angle [rpm]
	s2_min_speed	int16	Minimum speed	Mechanical angle [rpm]
	f4_ctrl_ref_id	float32	γ axis current command	[A]
	f4_boot_id_up_time	float32	Rise time at γ axis current startup	[ms]
	f4_id_const_time	float32	γ axis current/flux stabilization wait time	[ms]
	f4_accel	float32	Rotational speed command acceleration/deceleration step size	
	f4_fluctuation_limit	float32	Speed fluctuation limit	[rad/s]
	f4_delay	float32	Voltage output delay compensation coefficient	
	f4_offset_calc_time	float32	Current offset adjustment time	[ms]
	f4_voltage_drop	float32	Voltage drop correction threshold	[V]
	f4_voltage_drop_k	float32	Voltage drop correction gain	

3.5 Sensorless Vector Control Software Macros

The table below lists the macro definitions used in this control program.

Table 3.7 List of Macro Definitions (1/12)

File Name	Macro Name	Definition Value	Remarks
main.h	MAX_SPEED	CP_MAX_SPEED_RPM	Maximum value of the speed command (mechanical angle) [rpm]
	MIN_SPEED	CP_MIN_SPEED_RPM	Minimum value of the speed command (mechanical angle) [rpm]
	IQ_PI_KP	CP_IQ_PI_KP	δ axis current PI control proportional gain
	IQ_PI_KI	CP_IQ_PI_KI	δ axis current PI control integral gain
	SPEED_PI_KP	CP_SPEED_PI_KP	Speed PI control proportional gain
	SPEED_PI_KI	CP_SPEED_PI_KI	Speed PI control integral gain
	SPEED_LPF_K	CP_SPEED_LPF_K	Speed LPF gain
	CURRENT_LPF_K	CP_CURRENT_LPF_K	Current LPF gain
	STATOR_RESISTANCE	MP_STATOR_RESISTANCE	Stator resistance [Ω]
	ROTOR_RESISTANCE	MP_ROTOR_RESISTANCE	Rotor resistance [Ω]
	MUTUAL_INDUCTANCE	MP_MUTUAL_INDUCTANCE	Magnetizing inductance [H]
	STATOR_LEAKAGE_INDUCTANCE	MP_STATOR_LEAKAGE_INDUCTANCE	Stator leakage inductance [H]
	ROTOR_LEAKAGE_INDUCTANCE	MP_ROTOR_LEAKAGE_INDUCTANCE	Rotor leakage inductance [H]
	OFFSET_LPF_K	CP_OFFSET_LPF_K	Current offset value LPF gain
	CTRL_REF_ID	CP_CTRL_REF_ID	γ axis current command [A]
	BOOT_ID_UP_TIME	CP_BOOT_ID_UP_TIME	Rise time at γ axis current startup [ms]
	ID_CONST_TIME	CP_ID_CONST_TIME	γ axis current flux stabilization wait time [ms]
	ACCEL_MODE0	CP_ACCEL_MODE0	Acceleration
	FLUCTUATION_LIMIT	CP_FLUCTUATION_LIMIT	Speed fluctuation limit
	DELAY	CP_DELAY	Voltage output delay compensation coefficient
	OFFSET_CALC_TIME	CP_OFFSET_CALC_TIME	Current offset calculation time [ms]
	VOLTAGE_DROP	CP_VOLTAGE_DROP	Voltage drop compensation threshold [V]
	VOLTAGE_DROP_K	CP_VOLTAGE_DROP_K	Voltage drop compensation gain
	POLE_PAIRS	MP_POLE_PAIRS	Constant used for pole pairs count correction
	M_CW	0	Rotational direction
	M_CCW	1	
	ICS_INT_LEVEL	6	ICS interrupt priority level
	SW_ON	1	Active-high
	SW_OFF	0	

Table 3.7 List of Macro Definitions (2/12)

File Name	Macro Name	Definition Value	Remarks
motor_parameter.h	MP_POLE_PAIRS	1	Pole pairs count
	MP_STATOR_RESISTANCE	25.0	Stator resistance [Ω]
	MP_ROTOR_RESISTANCE	12.5	Rotor resistance [Ω]
	MP_MUTUAL_INDUCTANCE	1.00	Magnetizing inductance [H]
	MP_STATOR_LEAKAGE_INDUCTANCE	0.080	Stator leakage inductance [H]
	MP_INDUCTANCE	0.080	Rotor leakage inductance [H]

Table 3.7 List of Macro Definitions (3/12)

File Name	Macro Name	Definition Value	Remarks
mtr_ctrl_rx66t100_ t1102.h	MTR_PWM_TIMER_FREQ	160.0	PWM timer count frequency [MHz]
	MTR_CARRIER_FREQ	16.0	Carrier frequency [kHz]
	MTR_DEADTIME	2.5	Dead time [μ s]
	MTR_DEADTIME_SET	MTR_DEADTIME * MTR_PWM_TIMER_FREQ	Dead time setting
	MTR_AD_FREQ	40.0	A/D converter operating frequency [MHz]
	MTR_AD_SAMPLING_CYCLE	45.0	A/D conversion cycle count
	MTR_AD_SAMPLING_TIME	MTR_AD_SAMPLING_CYCLE / MTR_AD_FREQ	A/D conversion time [μ s]
	MTR_AD_TIME_SET	MTR_PWM_TIMER_FREQ * MTR_AD_SAMPLING_TIME	Setting used to assure the A/D conversion time
	MTR_CARRIER_SET	(MTR_PWM_TIMER_FREQ * 1000 / MTR_CARRIER_FREQ / 2) + MTR_DEADTIME_SET	Carrier setting
	MTR_HALF_CARRIER_SET	MTR_CARRIER_SET / 2	Carrier setting (intermediate value)
	MTR_PORT_UP	PORT7.PODR.BIT.B1	U phase (positive phase) output port
	MTR_PORT_UN	PORT7.PODR.BIT.B4	U phase (negative phase) output port
	MTR_PORT_VP	PORT7.PODR.BIT.B2	V phase (positive phase) output port
	MTR_PORT_VN	PORT7.PODR.BIT.B5	V phase (negative phase) output port
	MTR_PORT_WP	PORT7.PODR.BIT.B3	W phase (positive phase) output port
	MTR_PORT_WN	PORT7.PODR.BIT.B6	W phase (negative phase) output port
	MTR_PORT_LED1	PORTE.PODR.BIT.B3	LED1 output port
	MTR_PORT_LED2	PORTB.PODR.BIT.B7	LED2 output port
	MTR_LED_ON	0	Low active
	MTR_LED_OFF	1	
	MTR_INPUT_V	220 * 1.41421356	Power supply voltage [V]
	MTR_IC_GATE_ON_V	MTR_INPUT_V * 0.8	Power supply voltage $\times$ 80%[V]
	MTR_HALF_VDC	MTR_INPUT_V/2.0	Power supply voltage / 2 [V]
	MTR_ADC_SCALING	0x7FF	ADC offset adjustment constant
	MTR_CURRENT_SCALING	100.0f/4095.0	Resolution for use in A/D conversion of the measured current
	MTR_VDC_SCALING	686.0f/4095.0	Resolution for use in A/D conversion of the measured inverter bus voltage
	MTR_IPMTEMPERATURE_ SCALING	5.0f/4095.0	Resolution for use in A/D conversion of the measured IPM temperature
	MTR_OVERCURRENT_LIMIT	3.0	Current limit value [A]
	MTR_OVERVOLTAGE_LIMIT	420.0	High voltage limit value [V]
	MTR_UNDERVOLTAGE_ LIMIT	0.0	Low voltage limit value [V]
	MTR_ OVERIPMTEMPERATURE_ LIMIT	3	IPM temperature limit value [V]
	MTR_PORT_IC_GATE	PORT2.PODR.BIT.B4	Inrush current prevention circuit ports
	MTR_IC_GATE_ON	1	
	MTR_PORT_SW1	PORT1.PIDR.BIT.B0	SW1 input port
	MTR_PORT_SW2	PORT1.PIDR.BIT.B1	SW2 input port
	MTR_PORT_SW3	PORT8.PIDR.BIT.B2	SW3 input port

Table 3.7 List of Macro Definitions (4/12)

File Name	Macro Name	Definition Value	Remarks
mtr_3im_less_ foc.h	MTR_INT_DECIMATION	1	Interrupt decimation count
	MTR_CTRL_PERIOD	$(MTR_INT_DECIMATION + 1) / (MTR_CARRIER_FREQ * 1000)$	Control period [s]
	MTR_CONTROL_FREQ	$(MTR_CARRIER_FREQ * 1000) / (MTR_INT_DECIMATION + 1)$	Control frequency [Hz]
	MTR_POLE_PAIRS	MP_POLE_PAIRS	Pole pairs count
	MTR_RS	MP_STATOR_RESISTANCE	Stator resistance [Ω]
	MTR_RR	MP_ROTOR_RESISTANCE	Rotor resistance [Ω]
	MTR_M	MP_MUTUAL_INDUCTANCE	Magnetizing inductance [H]
	MTR_LLS	MP_STATOR_LEAKAGE_INDUCTANCE	Stator leakage inductance [H]
	MTR_LLR	MP_ROTOR_LEAKAGE_INDUCTANCE	Rotor leakage inductance [H]
	MTR_LS	MTR_M + MTR_LLS	
	MTR_LR	MTR_M + MTR_LLR	
	MTR_M_LR	MTR_M / MTR_LR	
	MTR_RR_LR	MTR_RR / MTR_LR	
	MTR_SIGMA	$1.0f - MTR_M / MTR_LS * MTR_M_LR$	
	MTR_LS_SIGMA	MTR_LS * MTR_SIGMA	
	MTR_TWOPI	$2 * 3.14159265$	2π
	MTR_TWOPI_3	MTR_TWOPI / 3	$2\pi / 3$
	MTR_SQRT_2	$1.41421356f$	$\sqrt{2}$
	MTR_SQRT_3	$1.7320508f$	$\sqrt{3}$
	MTR_SQRT_2_3	$0.81649658f$	$\sqrt{(2/3)}$
	MTR_RPM_RAD	MTR_TWOPI / 60	$2\pi / 60$
	MTR_IQ_PI_KP	CP_IQ_PI_KP	δ axis current PI control proportional gain
	MTR_IQ_PI_KI	CP_IQ_PI_KI	δ axis current PI control integral gain
	MTR_SPEED_PI_KP	CP_SPEED_PI_KP	Speed PI control proportional gain
	MTR_SPEED_PI_KI	CP_SPEED_PI_KI	Speed PI control integral gain
	MTR_SPEED_LPF_K	CP_SPEED_LPF_K	Speed LPF gain
	MTR_CURRENT_LPF_K	CP_CURRENT_LPF_K	Current LPF gain
	MTR_OFFSET_LPF_K	CP_OFFSET_LPF_K	Current offset value LPF gain
	MTR_LIMIT_ID	3.0	γ axis current PI control output limit value [A]
	MTR_I_LIMIT_ID	3.0	γ axis current PI control integral limit value [A]
	MTR_LIMIT_IQ	1.0	Speed PI control output limit value [A]
	MTR_I_LIMIT_IQ	1.0	Speed PI control integral limit value[A]
	MTR_MAX_SPEED_RPM	CP_MAX_SPEED_RPM	Maximum speed (mechanical angle) [rpm]
	MTR_MAX_SPEED_RAD	$MTR_MAX_SPEED_RPM * MTR_POLE_PAIRS * MTR_TWOPI / 60$	Maximum speed (electrical angle) [rad/s]
	MTR_MIN_SPEED_RPM	CP_MIN_SPEED_RPM	Minimum speed (mechanical angle) [rpm]
	MTR_MIN_SPEED_RAD	$MTR_MIN_SPEED_RPM * MTR_POLE_PAIRS * MTR_TWOPI / 60$	Minimum speed (electrical angle) [rad/s]

Table 3.7 List of Macro Definitions (5/12)

File Name	Macro Name	Definition Value	Remarks
mtr_3im_less_ foc.h	MTR_SPEED_LIMIT	MTR_MAX_SPEED_RAD * 1.3	Speed limit value [rad/s]
	MTR_LIMIT_ROTOR_SPEED_ RAD	MTR_MAX_SPEED_RAD * 1.2	δ axis current PI control output limit value [rad/s]
	MTR_I_LIMIT_ROTOR_ SPEED_RAD	MTR_MAX_SPEED_RAD * 1.2	δ axis current PI control integral limit value [rad/s]
	MTR_CTRL_REF_ID	CP_CTRL_REF_ID	γ axis current command
	MTR_BOOT_ID_UP_TIME	CP_BOOT_ID_UP_TIME	Rise time at γ axis current startup [ms]
	MTR_BOOT_ID_UP_STEP	CP_CTRL_REF_ID/MTR_BOOT_ ID_UP_TIME	Step size at γ axis current startup

Table 3.7 List of Macro Definitions (6/12)

File Name	Macro Name	Definition Value	Remarks
mtr_3im_less_ foc.h	MTR_ID_CONST_TIME	CP_ID_CONST_TIME	γ axis current/flux stabilization wait time [ms]
	MTR_ACCEL_MODE0	CP_ACCEL_MODE0	Acceleration
	MTR_FLUCTUATION_LIMIT	CP_FLUCTUATION_LIMIT	Speed fluctuation limit [rad/s]
	MTR_DELAY	CP_DELAY	Phase compensation constant
	MTR_ANGLE_COMPENSATION	MTR_DELAY * MTR_CTRL_PERIOD	
	MTR_OFFSET_CALC_TIME	CP_OFFSET_CALC_TIME	Current offset calculation time [ms]
	MTR_VOLTAGE_DROP	CP_VOLTAGE_DROP	Voltage drop correction threshold [V]
	MTR_VOLTAGE_DROP_K	CP_VOLTAGE_DROP_K	Voltage drop correction gain
	MTR_EVERY_TIME	0	Current value calculation
	MTR_ONE_TIME	1	Current offset value calculation (first time only)
	MTR_CW	0	Rotational direction
	MTR_CCW	1	
	MTR_FLG_CLR	0	Flag management
	MTR_FLG_SET	1	
	MTR_ID_UP	0	γ axis current increases
	MTR_ID_CONST	1	γ axis current is fixed
	MTR_ID_CONST_CTRL	2	Normal operation
	MTR_IQ_ZERO	0	δ axis current is 0
	MTR_IQ_SPEED_PI_OUTPUT	1	Normal operation
	MTR_BOOT_MODE	0x00	Boot mode
	MTR_START_MODE	0x01	Start mode
	MTR_CTRL_MODE	0x02	Control mode
	MTR_ZERO_PEC_MODE	0x00	Zero-position measurement mode
	MTR_OPENLOOP_MODE	0x01	Open-loop mode
	MTR_HALL_120_MODE	0x02	Hall sensor 120° operating mode
	MTR_LESS_120_MODE	0x03	BEMF sensorless 120° operating mode
	MTR_ENCD_FOC_MODE	0x04	Encoder vector operating mode
	MTR_LESS_FOC_MODE	0x05	Sensorless vector control mode
	MTR_OVER_CURRENT_ERROR	0x01	Overcurrent error
	MTR_OVER_VOLTAGE_ERROR	0x02	Overvoltage error
	MTR_OVER_SPEED_ERROR	0x03	Excessive speed error
	MTR_TIMEOUT_ERROR	0x04	Timeout error
	MTR_UNDER_VOLTAGE_ERROR	0x07	Low voltage error
	MTR_OVER_IPMTEMPERATURE_ERROR	0x08	IPM temperature abnormality error
	MTR_UNKNOWN_ERROR	0xff	Undefined error
	MTR_MODE_STOP	0x00	Stopped state
	MTR_MODE_RUN	0x01	Motor running state
	MTR_MODE_ERROR	0x02	Error state
	MTR_SIZE_STATE	3	Number of states
	MTR_EVENT_STOP	0x00	Motor stop event
	MTR_EVENT_RUN	0x01	Motor start event
	MTR_EVENT_ERROR	0x02	Motor error event
	MTR_EVENT_RESET	0x03	Motor reset event
	MTR_SIZE_EVENT	4	Number of events

Table 3.7 List of Macro Definitions (7/12)

File Name	Macro Name	Definition Value	Remarks
control_parameter.h	CP_ID_PI_KP	0.05	γ axis current PI control proportional gain
	CP_ID_PI_KI	0.05	γ axis current PI control integral gain
	CP_IQ_PI_KP	0.5	δ axis current PI control proportional gain
	CP_IQ_PI_KI	0.5	δ axis current PI control integral gain
	CP_SPEED_PI_KP	0.0025	Speed PI control proportional gain
	CP_SPEED_PI_KI	0.00005	Speed PI control integral gain
	CP_SPEED_LPF_K	0.3	Speed LPF gain
	CP_CURRENT_LPF_K	1.0	Current LPF gain
	CP_OFFSET_LPF_K	0.1	Current offset value LPF gain
	CP_MAX_SPEED_RPM	2000	Maximum speed (mechanical angle) [rpm]
	CP_MIN_SPEED_RPM	500	Minimum speed (mechanical angle) [rpm]
	CP_CTRL_REF_ID	0.4	γ axis current command
	CP_BOOT_ID_UP_TIME	100.0	Rise time at γ axis current startup [ms]
	CP_ID_CONST_TIME	500.0	γ axis current/flux stabilization wait time [ms]
	CP_ACCEL_MODE0	0.1	Acceleration during start mode [rad/s^2]
	CP_FLUCTUATION_LIMIT	200.0	Speed fluctuation limit [rad/s]
	CP_DELAY	1.0	Phase delay compensation constant
	CP_OFFSET_CALC_TIME	256	Current offset calculation time [ms]
	CP_VOLTAGE_DROP	8.0	Voltage drop correction threshold [V]
	CP_VOLTAGE_DROP_K	0.0	Voltage drop correction gain

Table 3.7 List of Macro Definitions (8/12)

File Name	Macro Name	Definition Value	Remarks
r_init_clock.h	B_NOT_USE	0	Not in use
	B_USE	1	In use
	B_USE_PLL_MAIN	2	Use the PLL clock. (Clock source: the main clock)
	B_USE_PLL_HOCO	3	Use the PLL clock. (Clock source: HOCO)
	REG_VOLSR *2	C0h	Used in making the following settings: Usage of the USB, usage of the PGA pseudo-differential input and its voltage, and the level of the VCC voltage when the RIIC is in use (the value to be set in the VOLSR register).
	SEL_MAIN	B_USE	Used in selecting oscillation or stopping of the main clock. B_USE: In use (the main clock oscillates) B_NOT_USE: Not in use (the main clock is stopped)
	MAIN_CLOCK_Hz	8000000L	Number of frequencies of the main clock oscillator (Hz)
	REG_MOFCR	30h	For setting the driving ability of the main clock oscillator (the value to be set in the MOFCR register)
	REG_MOSCWTCR	53h	The value set in the wait control register for the main clock
	REG_PLLCR *1, *2	1F11h (When the PLL clock is sourced from the HOCO clock) 2700h (Other than above)	Setting of the division ratio and multiplication factor for the PLL (the value to be set in the PLLCR register). 1F11h: Selects the HOCO clock as the clock source with division by 2 and multiplication by 16 2700h: Selects the main clock as the clock source with division by 1 and multiplication by 20.
	SEL_PLL	B_USE_PLL_MAIN	Used in selecting oscillation or stopping of the PLL clock. B_USE_PLL_MAIN: In use (with the main clock as the source for the PLL) B_USE_PLL_HOCO: In use (with the HOCO clock as the source for the PLL) B_NOT_USE: Not in use (the PLL clock is stopped)
	SEL_HOCO	B_NOT_USE	Used in selecting oscillation or stopping of the HOCO clock. B_USE: In use (the HOCO clock oscillates) B_NOT_USE: Not in use (the HOCO clock is stopped)

Note 1. The meanings of the values depend on the clock source selected for the system clock.

Note 2. Change the setting value of the PLLCR register as required in accord with the description of the RX66T Group User's Manual: Hardware.

Table 3.7 List of Macro Definitions (9/12)

File Name	Macro Name	Definition Value	Remarks
r_init_clock.h	FREQ_16MHz	00h	Number of frequencies of HOCO: 16 MHz
	FREQ_18MHz	01h	Number of frequencies of HOCO: 18 MHz
	FREQ_20MHz	02h	Number of frequencies of HOCO: 20 MHz
	REG_HOCOCR2	FREQ_20MHz	The number of frequencies of HOCO FREQ_16MHz: 16 MHz FREQ_18MHz: 18 MHz FREQ_20MHz: 20 MHz
	CLK_HOCO	0100h	Clock source: PLL
	CLK_MAIN	0200h	Clock source: HOCO
	CLK_PLL	0400h	Clock source: The main clock
	SEL_SYSCLK	CLK_PLL	The clock source for the system clock. CLK_PLL: PLL CLK_HOCO: HOCO CLK_MAIN: The main clock
	REG_SCKCR *1, *2	2082 1202h (when PLL is selected) 0080 0000h (when HOCO is selected) 0080 0000h (other than above)	Used in setting the division ratio for the internal clock signals and the PCLK control (value to be set in the SCKCR register)
	REG_SCKCR2	0011h	Division ratio for the USB clock (when the USB is not in use).
	MEMWAIT_1WAIT	0	Memory wait cycles: 0 cycle
	MEMWAIT_0WAIT	1	Memory wait cycles: 1 cycle
	REG_MEMWAIT *3	MEMWAIT_1WAIT	Used in selecting the number of memory wait cycles. MEMWAIT_0WAIT: 0 cycle MEMWAIT_1WAIT: 1 cycle

Note 1. The meanings of the values depend on the clock source selected for the system clock.

Note 2. Change the setting value of the SCKCR register as required in accord with the description of the RX66T Group User's Manual: Hardware.

Note 3. If ICLK is faster than 120 MHz, set the number of wait cycles to 1.

Table 3.7 List of Macro Definitions (10/12)

File Name	Macro Name	Definition Value	Remarks
r_init_port_initialize.h	WITH	1	Function included
	WITHOUT	0	Function not included
	PGA_DEFAMP	WITH	Used in selecting the product with/without the PGA pseudo differential input. WITHOUT: Product without the PGA pseudo differential input WITH: Product with the PGA pseudo differential input
	USB_MODULE	WITHOUT	Used in selecting the product with/without the USB. WITHOUT: Product without the USB WITH: Product with the USB
	PIN_SIZE	100	The number of pins for use

Table 3.7 List of Macro Definitions (11/12)

File Name	Macro Name	Definition Value	Remarks
r_init_rom_cache.h	CACHE_ENABLE	1	Enables caching of the ROM
	CACHE_DISABLE	0	Disables caching of the ROM
	NON_CACHEABLE_AREA_DISABLE	0	Disables the non-cacheable area
	NON_CACHEABLE_AREA_ENABLE	1	Enables the non-cacheable area
	SEL_ROM_CACHE	CACHE_ENABLE	Enables or disables caching of the ROM. CACHE_ENABLE: Enables caching CACHE_DISABLE: Disables caching
	SEL_NON_CACHEABLE_AREA0	NON_CACHEABLE_AREA_DISABLE	Selects enabling or disabling of non-cacheable area 0. NON_CACHEABLE_AREA_ENABLE: Enabled NON_CACHEABLE_AREA_DISABLE: Disabled
	SEL_NON_CACHEABLE_AREA1	NON_CACHEABLE_AREA_DISABLE	Selects enabling or disabling of non-cacheable area 1. NON_CACHEABLE_AREA_ENABLE: Enabled NON_CACHEABLE_AREA_DISABLE: Disabled

Table 3.7 List of Macro Definitions (12/12)

File Name	Macro Name	Definition Value	Remarks
r_init_stop_module.h	MODULE_STOP_ ENABLE	1	Enters the module-stop state.
	MODULE_STOP_ DISABLE	0	Exits the module-stop state.
	MSTP_STATE_ DMACDTC	MODULE_STOP_ DISABLE	Selects entry to or exit from the module-stop state by the DMAC and DTC. MODULE_STOP_DISABLE: Exits the module-stop state. MODULE_STOP_ENABLE: Enters the module-stop state.
	MSTP_STATE_ ECCRAM	MODULE_STOP_ DISABLE	Selects entry to or exit from the module-stop state by the ECCRAM. MODULE_STOP_DISABLE: Exits the module-stop state. MODULE_STOP_ENABLE: Enters the module-stop state.
	MSTP_STATE_ RAM	MODULE_STOP_ DISABLE	Selects entry to or exit from the module-stop state by the RAM. MODULE_STOP_DISABLE: Exits the module-stop state. MODULE_STOP_ENABLE: Enters the module-stop state.

3.6 Control Flow (Flowcharts)

3.6.1 Main Processing

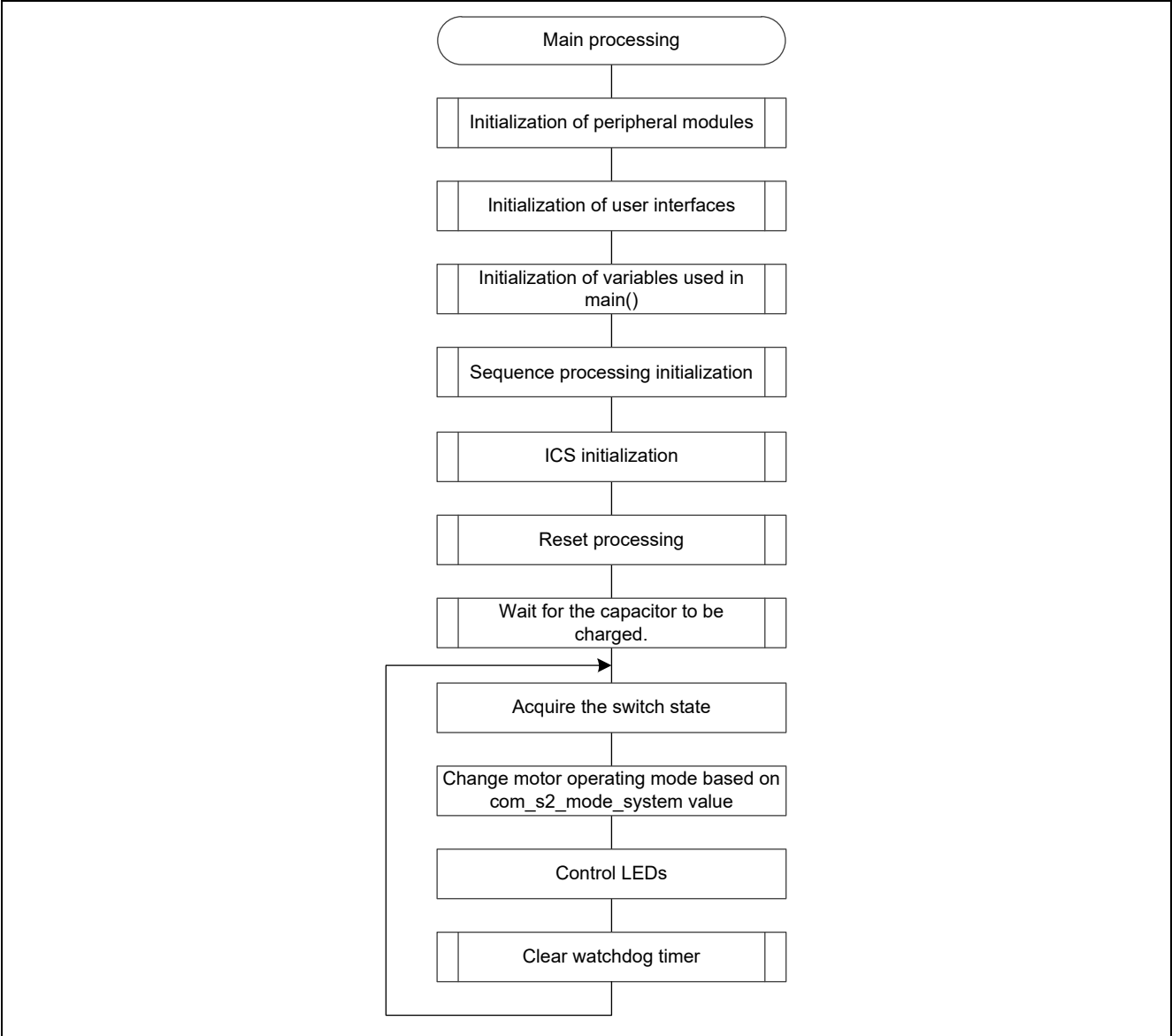


Figure 3.4 Main Processing

3.6.2 125- μ s Period Interrupt Handling

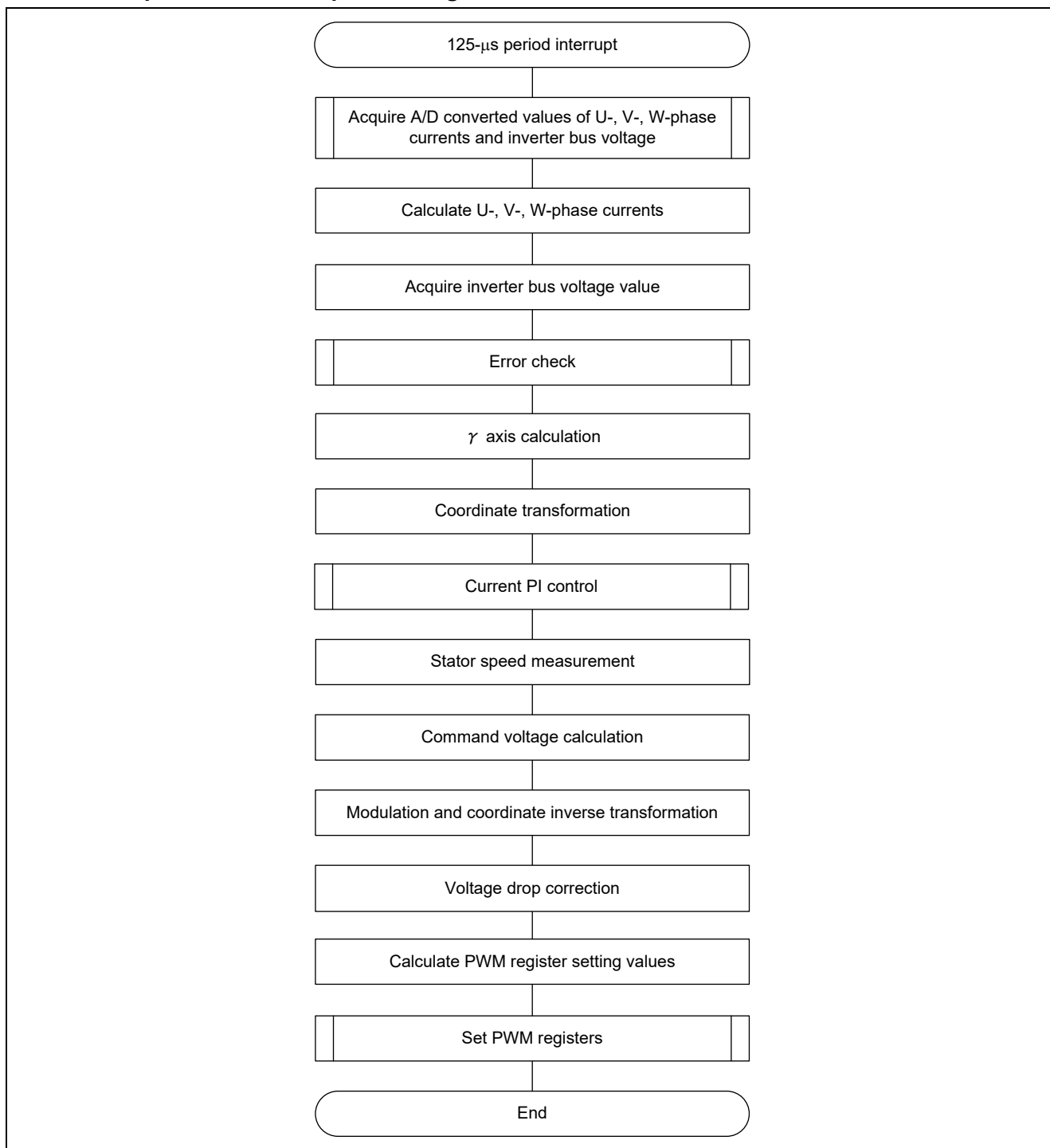


Figure 3.5 125- μ s Period Interrupt Handling

3.6.3 1-ms Interrupt Handling

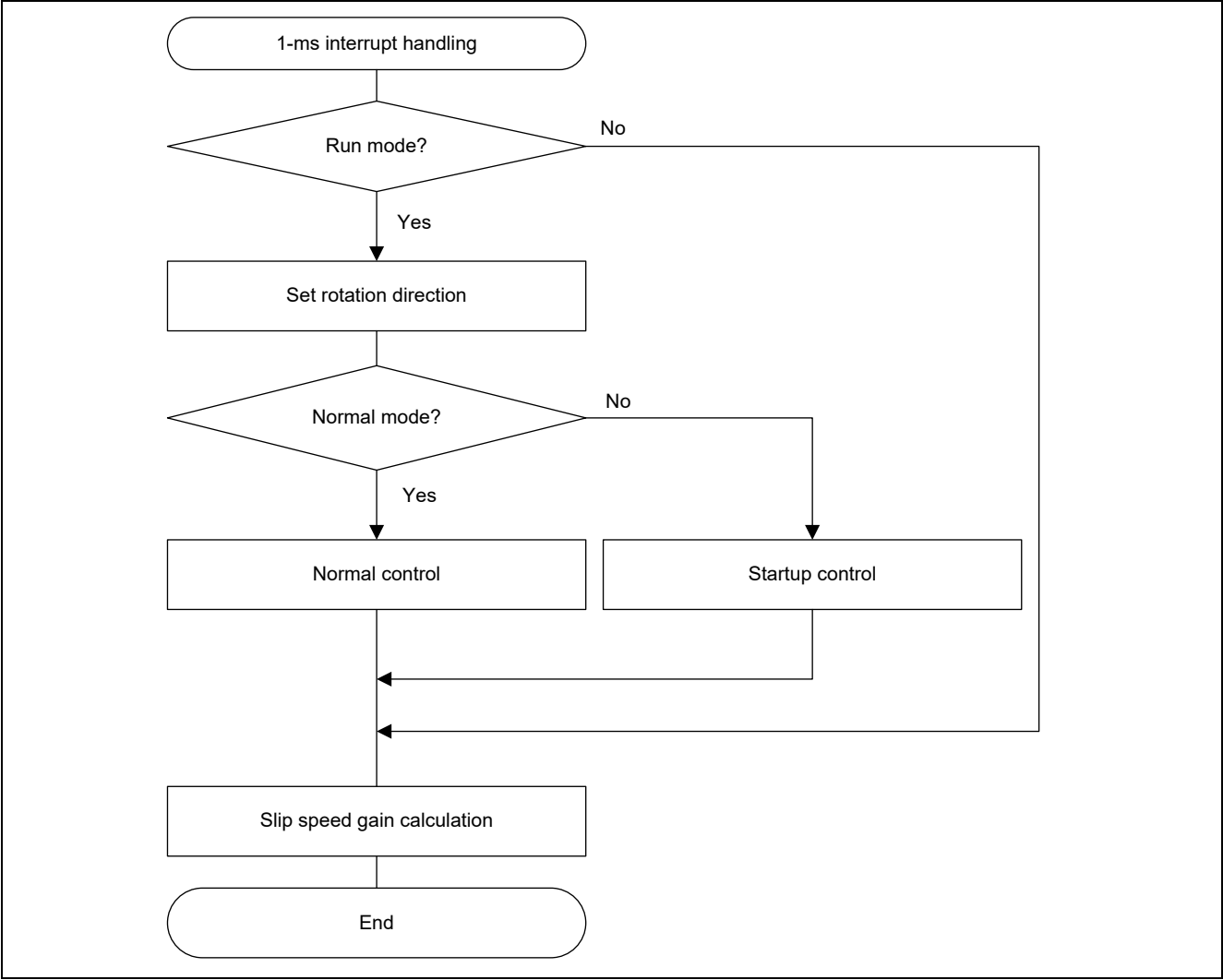


Figure 3.6 1-ms Interrupt Handling

3.6.4 Handling of Group Interrupt that Includes Overcurrent Detection as a Source

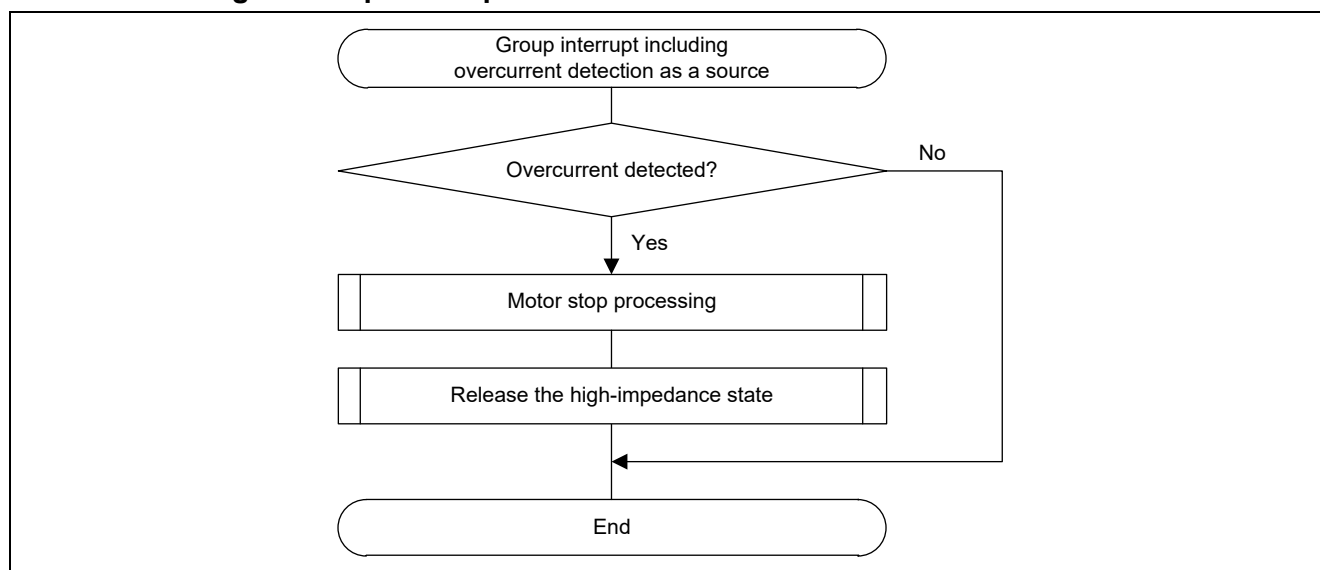


Figure 3.7 Handling of Group Interrupt that Includes Overcurrent Detection as a Source

4. Development Support Tool “In Circuit Scope”

4.1 Overview

‘Renesas Motor Workbench 2.0’ is support tool for development of motor control system. ‘Renesas Motor Workbench 2.0’ can be used with target software of this application note to analyze the control performance. The user interfaces of ‘Renesas Motor Workbench 2.0’ provide functions like rotating start/stop command, setting rotation speed command, etc...Please refer to ‘Renesas Motor Workbench 2.0 User’s Manual’ for usage and more details.

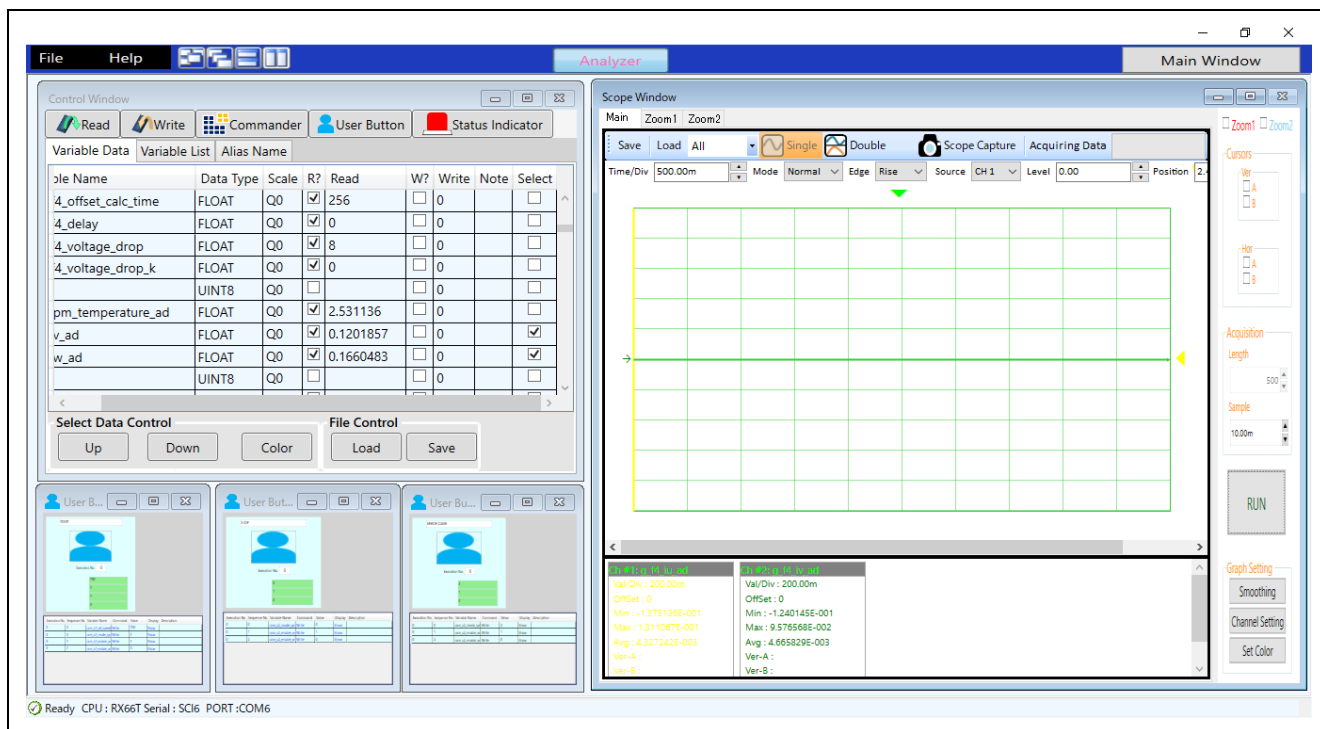


Figure 4.1 Renesas Motor Workbench-Appearance

4.2 The Usage of RMW

Following shows how to use RMW to operate a motor. The RMW screen is shown in Figure 4.2. The screen consists of three parts of the window. The control window is located in the upper left corner, the user button is located in the lower left corner, and the scope window is located in the right side. In RMW, the user button is used for basic operations, such as starting/stopping the motor. The function of each button is shown below.

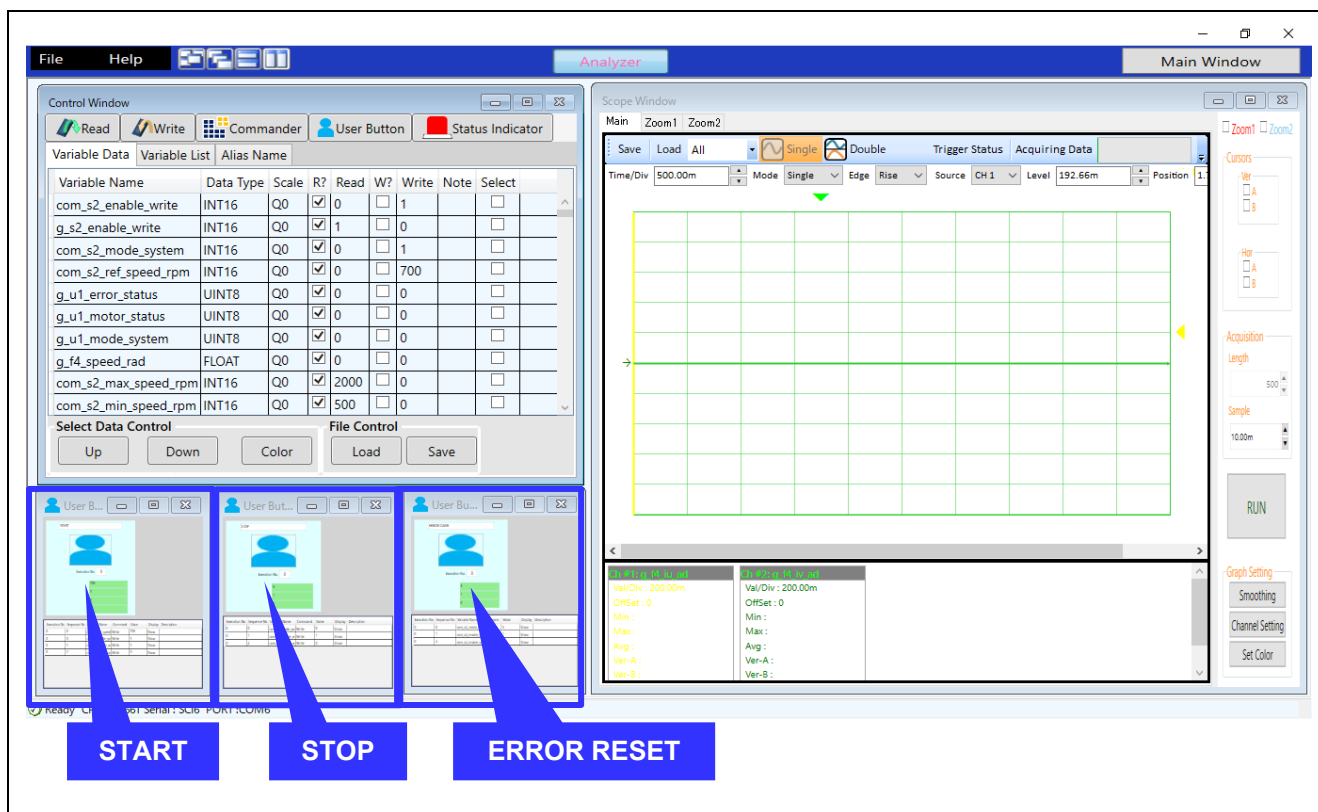


Figure 4.2 The Usage of RMW

4.2.1 START Button

The user button located on the left side is the START button. Use this button to set speed command value and operate the motor. Enter the speed command value in rpm unit in the value column of 'com_s2_ref_speed_rpm'. Then click the image part in the button to transition to the motor operating state and accelerate to the set speed command value. However if errors occurred, the motor will not operating.

To change the motor rotation speed in the operating state, change the speed command value and click the image part of the button to accelerate or decelerate the motor.

4.2.2 STOP Button

The user button located in the center is the STOP button. Click the image part in the button to switch to the motor stop state.

4.2.3 ERROR RESET Button

The user button located in the right side is the ERROR RESET button. Click the image part in the button to resets the error status.

4.2.4 Change Parameter Setting

The following is an example using RMW to change maximum speed value. The procedure for changing parameters are shown in Figure 4.3 and Figure 4.4. The same procedure is used to change the other parameters.

To set and write parameters as shown in steps 1 and 2 in Figure 4.3. When the START button is pressed to operate the motor, the set parameters are reflected in the motor control layer variables. Figure 4.4 shows. The result when the speed command is set to 1000rpm. Although the speed command value is set to 1000rpm, the maximum speed is limited to 800rpm.

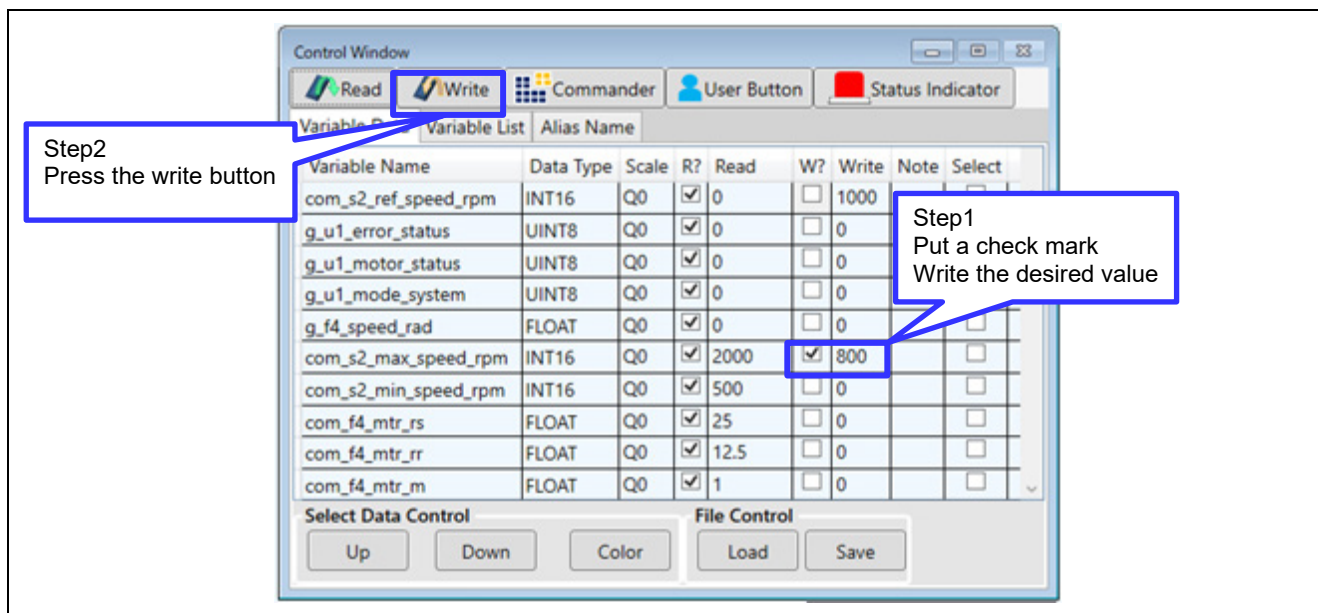


Figure 4.3 Setting parameters

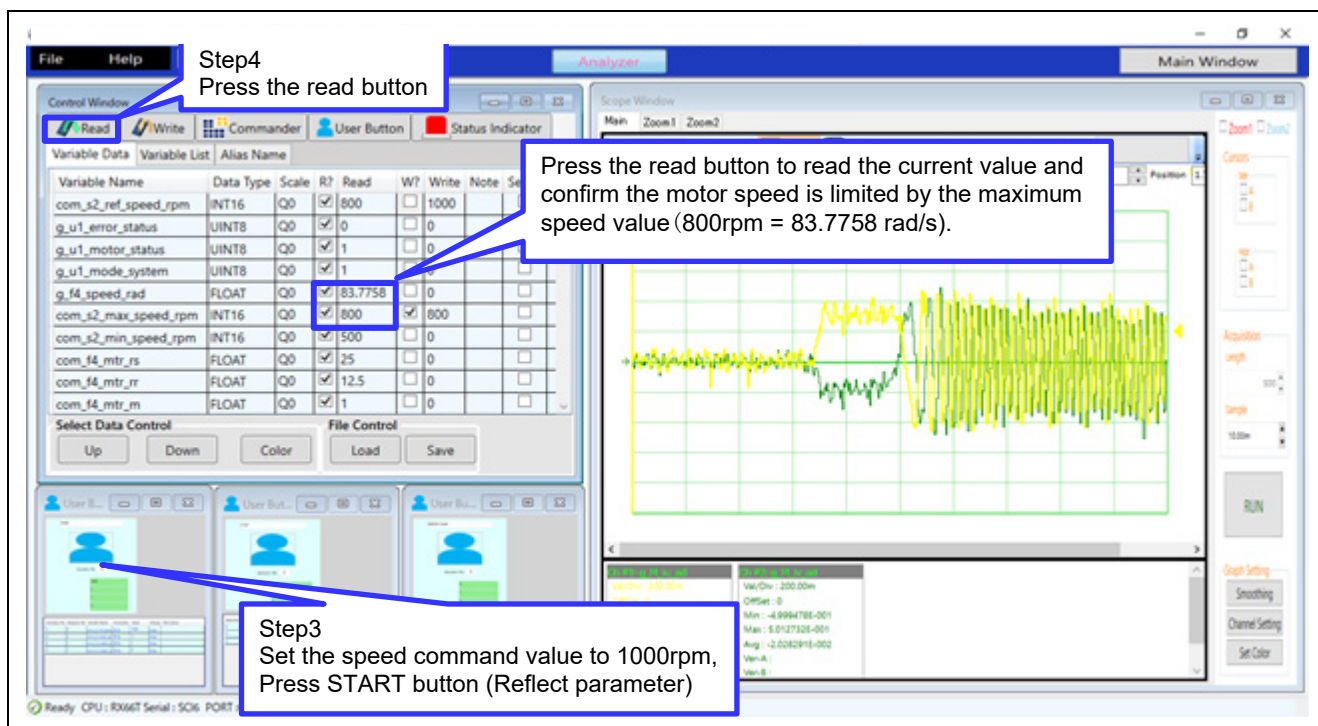


Figure 4.4 Parameter reflection confirmation

4.3 RMW Variables

Table 4.1 lists the variables for use with the RMW. Note that modifications to these variables will not be reflected in the motor control layer variables at the point these RMW variables are modified. The motor control layer variables are written and modified at the point the value of `g_s2_enable_write` is written to `com_s2_enable_write`.

Table 4.1 RMW Variables

RMW Variable	Type	Usage	Target Variable (Motor Control Layer Variable)
<code>com_s2_mode_system</code>	int16	State management 0: Stop mode 1: Run mode 3: Reset	This variable's value is reflected in <code>g_s2_mode_system</code> at the point it is written.
<code>Com_s2_direction</code>	int16	Rotational direction	<code>g_u1_dir_buff</code>
<code>com_s2_ref_speed_rpm</code>	int16	Speed command	<code>g_f4_ref_speed_rad</code>
<code>com_f4_kp_speed</code>	float32	Speed PI control proportional gain	<code>g_f4_kp_speed</code>
<code>com_f4_ki_speed</code>	float32	Speed PI control integral gain	<code>g_f4_ki_speed</code>
<code>com_f4_kp_iq</code>	float32	δ axis current PI control proportional gain	<code>g_f4_kp_iq</code>
<code>com_f4_ki_iq</code>	float32	δ axis current PI control integral gain	<code>g_f4_ki_iq</code>
<code>com_f4_speed_lpf_k</code>	float32	Speed LPF gain	<code>g_f4_speed_lpf_k</code>
<code>com_f4_current_lpf_k</code>	float32	Current LPF gain	<code>g_f4_current_lpf_k</code>
<code>com_f4_mtr_rs</code>	float32	Stator resistance	<code>mtr_p.f4_mtr_rs</code>
<code>com_f4_mtr_rr</code>	float32	Rotor resistance	<code>mtr_p.f4_mtr_rr</code>
<code>com_f4_mtr_m</code>	float32	Magnetizing inductance	<code>mtr_p.f4_mtr_m</code>
<code>com_f4_mtr_lls</code>	float32	Stator leakage resistance	<code>mtr_p.f4_mtr_ls</code>
<code>com_f4_mtr_llr</code>	float32	Rotor leakage inductance	<code>mtr_p.f4_mtr_lr</code>
<code>com_f4_offset_lpf_k</code>	float32	Current offset LPF gain	<code>g_f4_offset_lpf_k</code>
<code>com_s2_max_speed_rpm</code>	int16	Maximum speed	<code>g_f4_max_speed_rad</code>
<code>com_s2_min_speed_rpm</code>	int16	Minimum speed	<code>g_f4_min_speed_rad</code>
<code>com_f4_ctrl_ref_id</code>	float32	γ axis current command	<code>g_f4_ctrl_ref_id</code>
<code>com_f4_boot_id_up_time</code>	float32	Rise time at γ axis current startup	<code>g_f4_boot_id_up_step</code>
<code>com_f4_id_const_time</code>	float32	γ axis current/flux stabilization wait time	<code>g_f4_id_const_time</code>
<code>com_f4_accel</code>	float32	Rotational frequency command acceleration step size	<code>g_f4_accel</code>
<code>com_f4_fluctuation_limit</code>	float32	Speed fluctuation limit	<code>g_f4_fluctuation_limit</code>
<code>com_f4_offset_calc_time</code>	float32	Current offset adjustment time	<code>g_f4_offset_calc_time</code>
<code>com_f4_delay</code>	float32	Voltage output delay compensation coefficient	<code>g_f4_angle_compensation</code>
<code>com_f4_voltage_drop</code>	float32	Voltage drop correction threshold	<code>g_f4_voltage_drop</code>
<code>com_f4_voltage_drop_k</code>	float32	Voltage drop correction gain	<code>g_f4_voltage_drop_k</code>
<code>com_s2_enable_write</code>	int16	Variable write enable	—

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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Aug 31, 20	—	First edition issued
1.10	Apr 21, 21	4	Updated version of CS+ to 8.05.00
		27	Updated Table 3.7 List of Macro Definitions (3/12)
		31	Updated Table 3.7 List of Macro Definitions (7/12)

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.5.0-1 October 2020)

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